

100V 1.25mohm N-channel SGT MOSFET
AKG10N012TM-A

Description:

This device is designed for automotive applications and manufactured in IATF16949 certified facilities. Qualified AEC-Q101, PPAP capable.

Features:

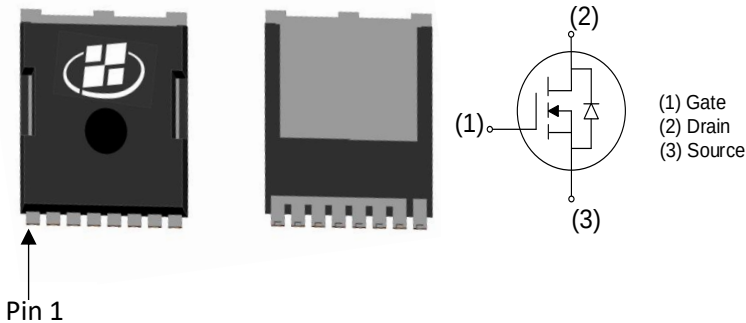
- Ultra-low on-resistance
- RoHS compliant (Note 1)
- Halogen-free (Note 1)
- 100% UIS tested
- AEC-Q101 qualified and PPAP capable
- Wettable Flank for Improved Optical Inspection

Applications:

- Battery Management System
- Motor Drivers
- DC-DC Converter

Key Performance Parameters:

Parameter	Value	Unit
V_{DS}	100	V
$R_{DS(on), max} @V_{GS} = 10\text{ V}$	1.25	mΩ
I_D	300	A



Ordering Information:

Ordering Code	Package Type	Marking Code	Form	Packing
AKG10N012TM-A	TOLL	G10N012TM	Tape Reel	2000PCS

Notes:

1. Contact ALKAIDSEMI sales for detail information

Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Units
V_{DS}	Drain-Source Voltage	100	V
I_D	Drain Current - Continuous ($T_C = 25^\circ\text{C}$) ^(Note 1)	367	A
	Drain Current - Continuous ($T_C = 25^\circ\text{C}$) ^(Note 2)	300	A
	Drain Current - Continuous ($T_C = 100^\circ\text{C}$)	260	A
I_{DM}	Drain Current - Pulsed ^(Note 3)	1200	A
V_{GS}	Gate-Source Voltage	± 20	V
E_{AS}	Single Pulsed Avalanche Energy ^(Note 4)	1600	mJ
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$)	300	W
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +175	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Steady-State	0.5	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Steady State ^(Note 5)	50	$^\circ\text{C/W}$

Notes:

1. The max drain current rating is silicon limited
2. The max drain current rating is package limited
3. Repetitive Rating: Pulse width limited by maximum junction temperature
4. $L = 0.5\text{ mH}$, $V_{DD} = 50\text{ V}$, $I_{AS} = 80\text{ A}$, $R_G = 25\ \Omega$, Starting $T_J = 25\ ^\circ\text{C}$
5. Mount on minimum PCB layout

Electrical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Static Characteristics

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	100			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80\text{ V}, V_{GS} = 0\text{ V}$			1	μA
I_{GSS}	Gate Leakage Current	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$			± 100	nA
$V_{GS(TH)}$	Gate Threshold voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	2	2.8	4	V
$R_{DS(ON)}$	Drain-Source on-state resistance	$V_{GS} = 10\text{ V}, I_D = 20\text{ A}$		0.98	1.25	m Ω

Dynamic Characteristics

C_{ISS}	Input Capacitance	$V_{DS} = 50\text{ V}, V_{GS} = 0\text{ V},$ $F = 1\text{ MHz}$		20760		pF
C_{OSS}	Output Capacitance			4310		pF
C_{RSS}	Reverse Transfer Capacitance			117		pF
R_G	Gate Resistance	$F = 1\text{ MHz}$		2.3		Ω

Switching Characteristics

$T_{D(ON)}$	Turn On Delay Time	$V_{DD} = 50\text{ V}, R_L = 2.5\text{ }\Omega,$ $V_{GS} = 10\text{ V}, R_G = 1.6\text{ }\Omega$		49		nS
T_R	Rise Time			48.0		nS
$T_{D(OFF)}$	Turn Off Delay Time			143		nS
T_F	Fall Time			63		nS
Q_G	Total Gate Charge	$V_{DD} = 50\text{ V}, I_D = 20\text{ A},$ $V_{GS} = 10\text{ V}$		291		nC
Q_{GS}	Gate-Source Charge			71		nC
Q_{GD}	Gate-Drain Charge			49		nC

Drain-Source Diode Characteristics and Maximum Ratings

I_S	Maximum Continuous Body-Diode Forward Current			300	A
I_{SM}	Maximum Pulsed Body-Diode Forward Current ^(NOTE 1)			1200	A
V_{SD}	Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 20\text{ A}$		0.85	V
T_{RR}	Reverse recovery time	$V_{DD} = 50\text{ V}, I_D = 20\text{ A},$ $di/dt = 100\text{ A}/\mu\text{S}$		133	nS
Q_{RR}	Reverse recovery charge			374	nC
I_{RRM}	Peak Reverse Recovery Current			5	A

Electrical Characteristics Diagrams

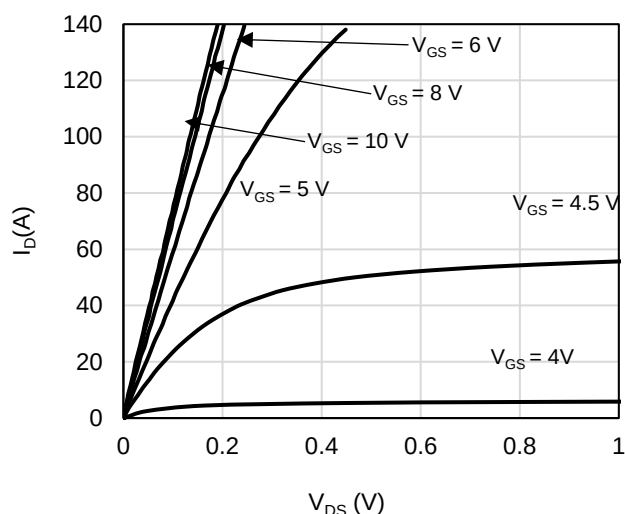


Figure 1: On-Region Characteristics

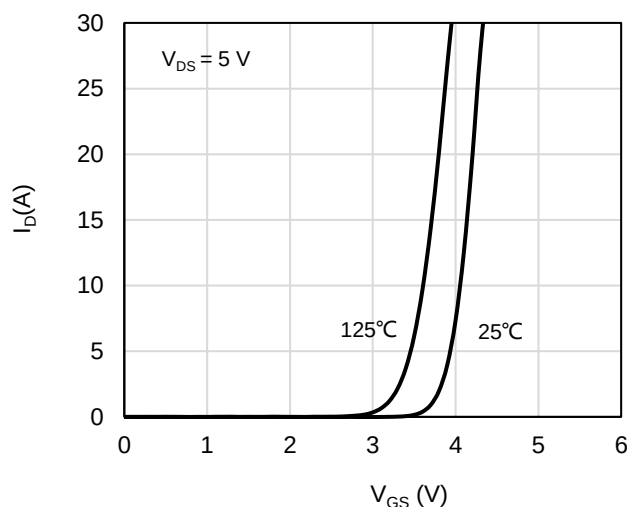


Figure 2: Transfer Characteristics

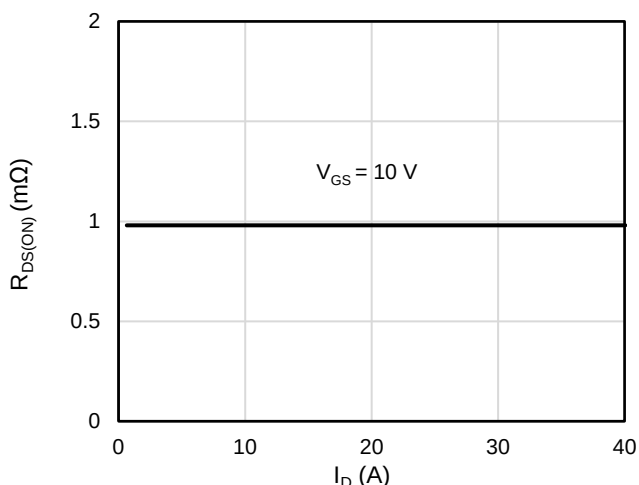


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

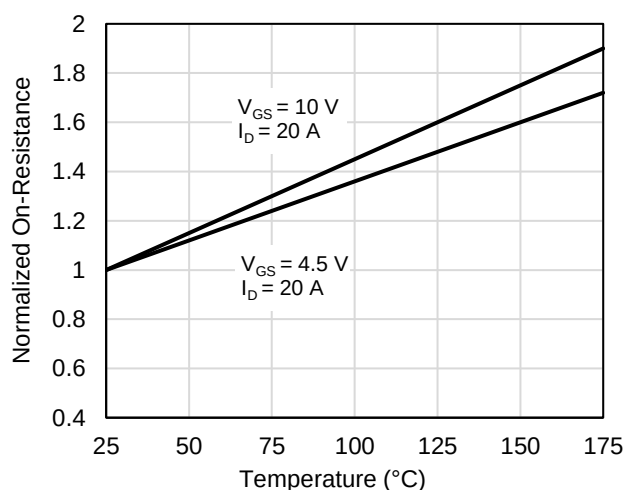


Figure 4: On-Resistance vs. Junction Temperature

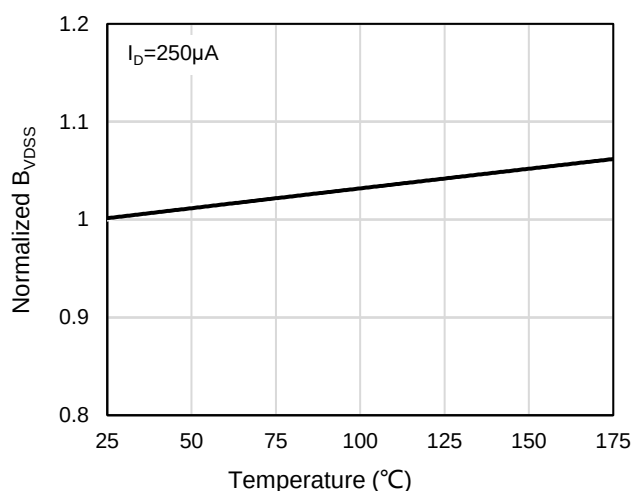


Figure 5: Breakdown Voltage vs. Junction Temperature

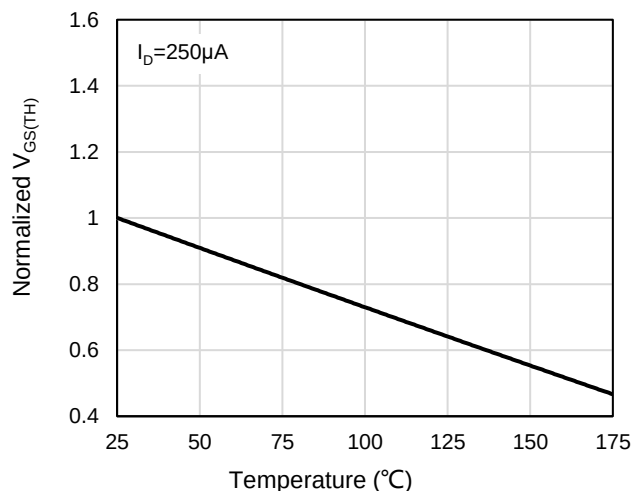


Figure 6: Threshold Voltage vs. Junction Temperature

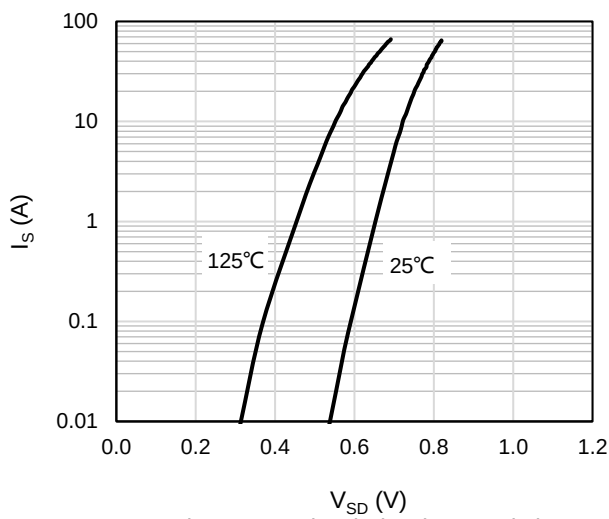


Figure 7: Body-Diode Characteristics

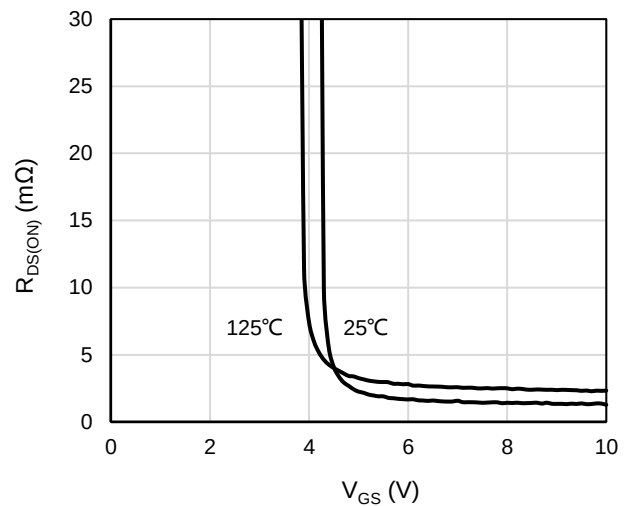


Figure 8: On-Resistance vs. Gate-Source Voltage

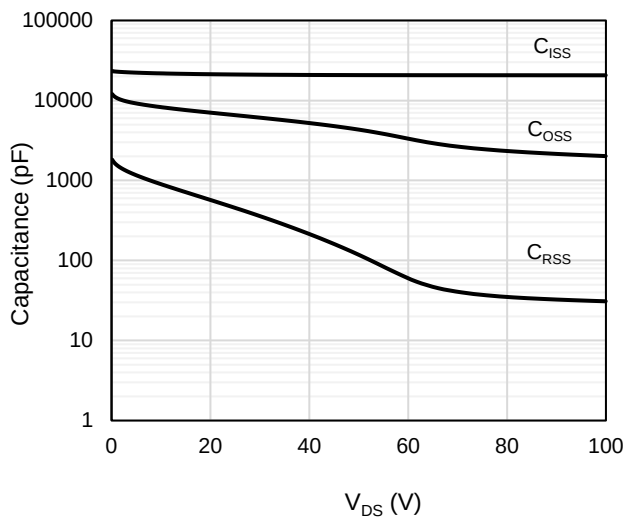


Figure 9: Capacitance Characteristics

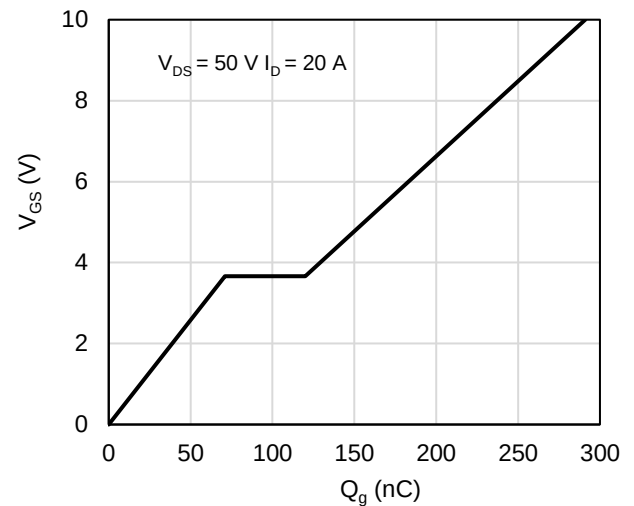


Figure 10: Gate-Charge Characteristics

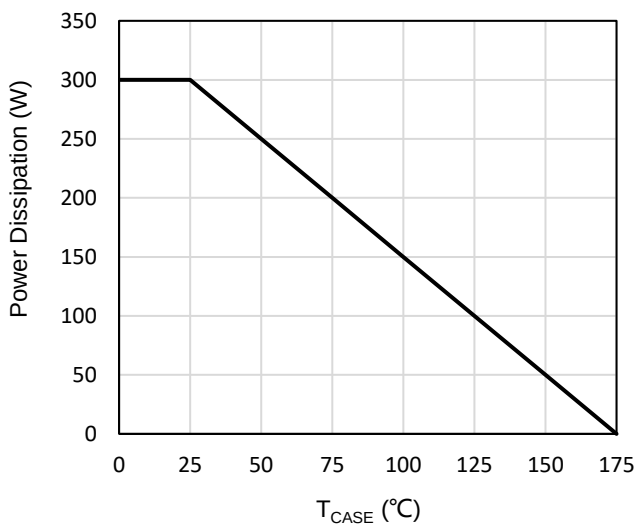


Figure 11: Power De-rating

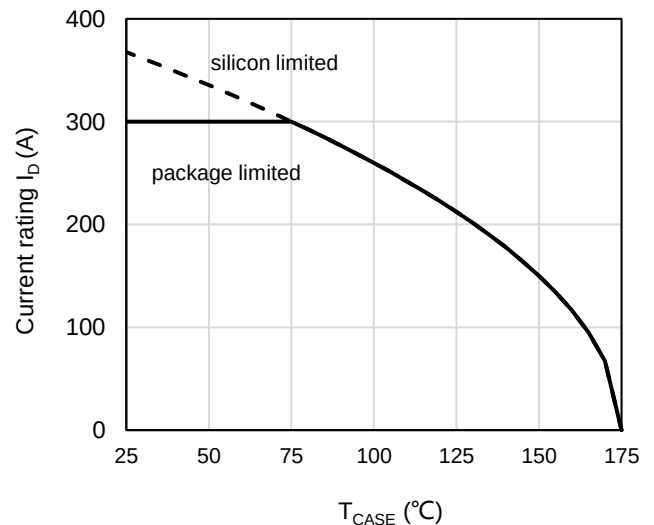
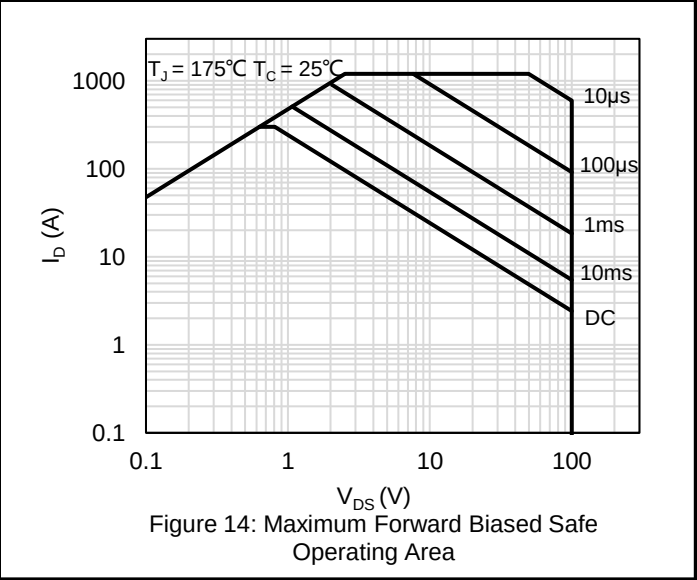
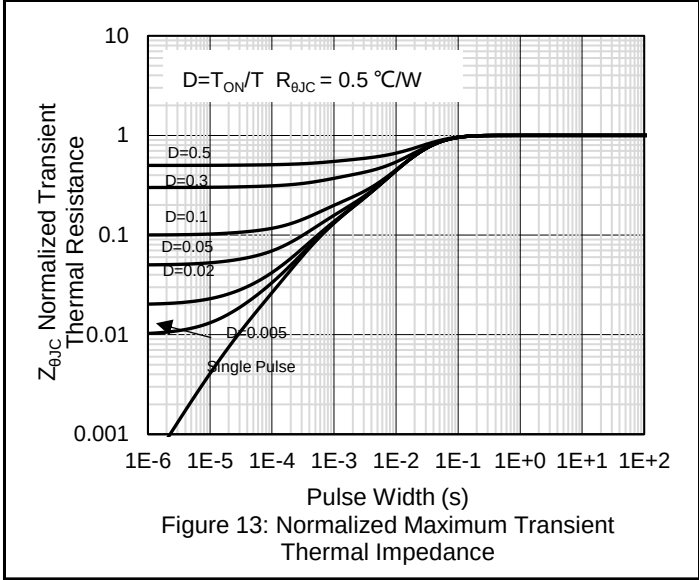
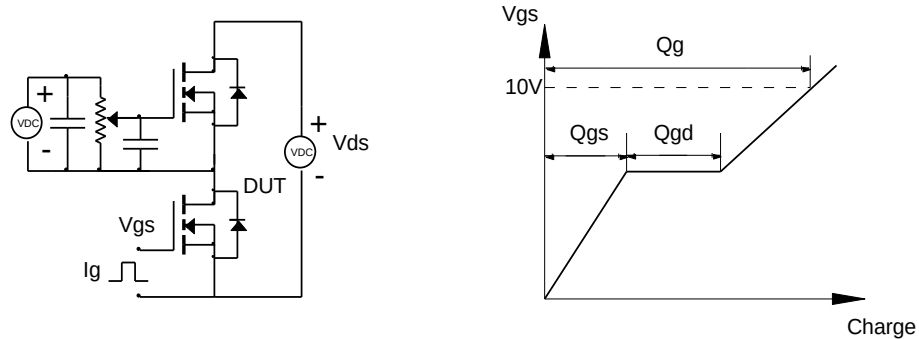


Figure 12: Current De-rating

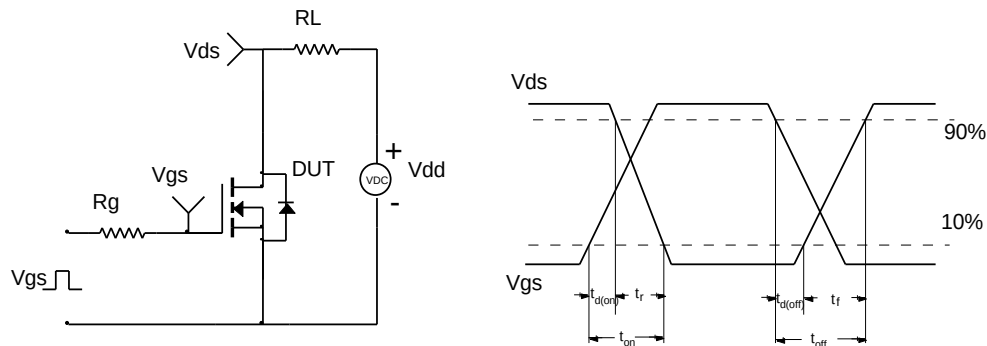


Test Circuit and Waveform

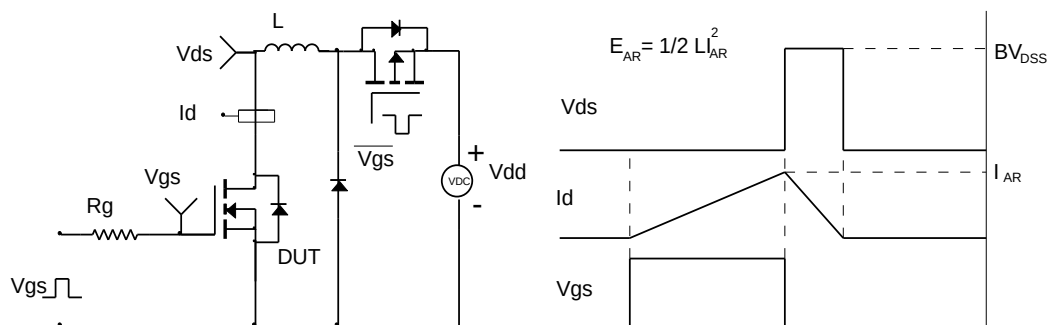
Gate Charge Test Circuit & Waveform



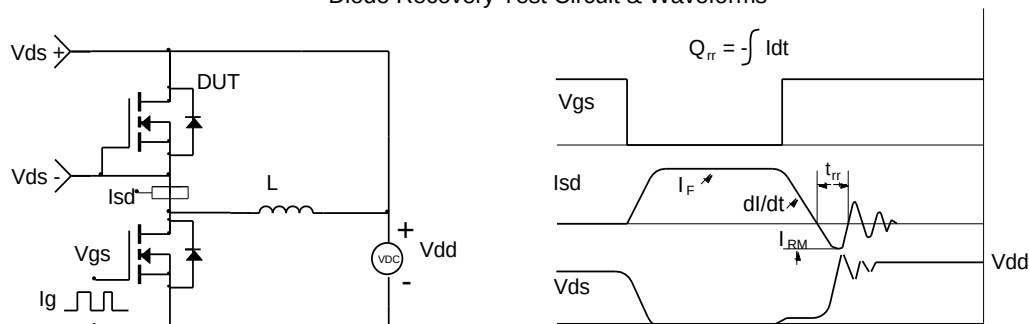
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

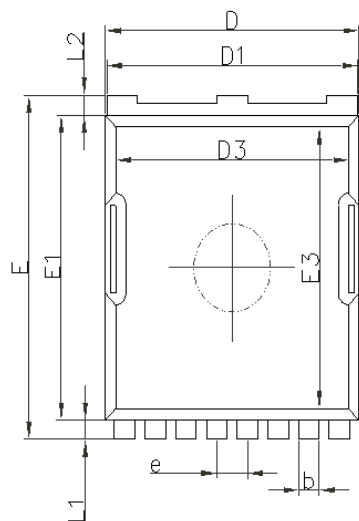


Diode Recovery Test Circuit & Waveforms

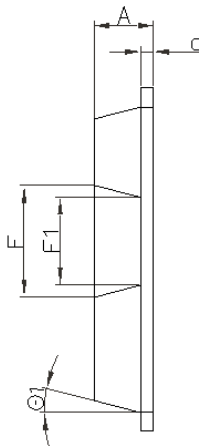


Package Outlines

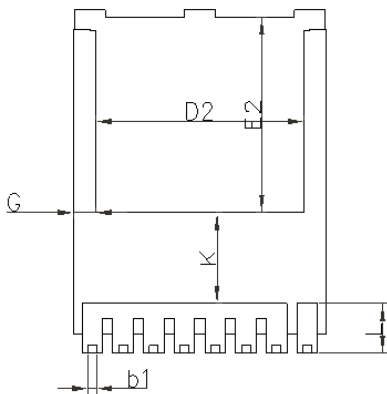
POD1



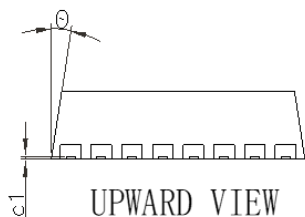
TOP VIEW



SIDE VIEW



BTM VIEW



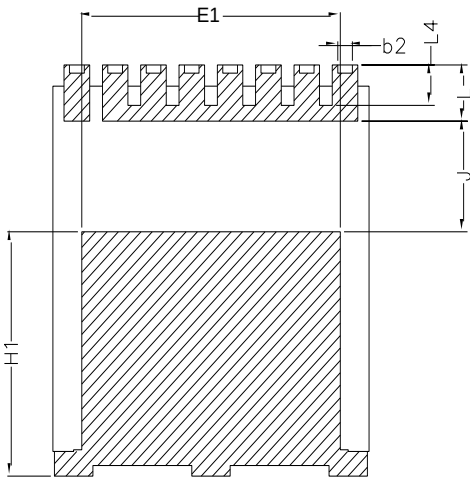
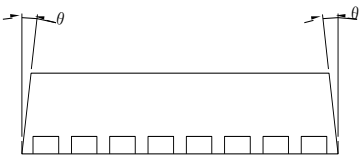
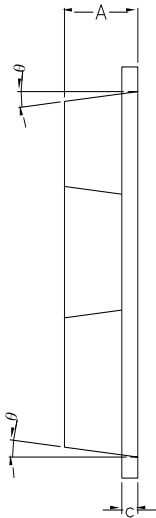
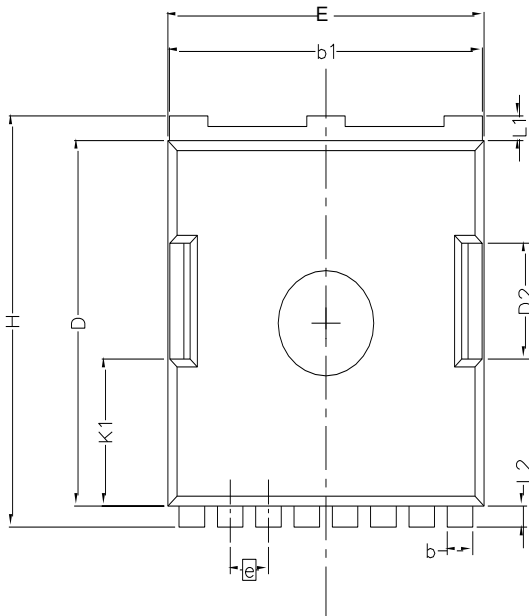
UPWARD VIEW

SYMBOL	MIN	NDM	MAX
A	2.20	2.30	2.40
b	0.75	0.80	0.85
b1	0.30	0.35	0.40
c	0.45	0.50	0.55
c1	0.05	0.10	0.15
D	9.80	9.90	10.00
D1	9.70	9.80	9.90
D2	8.00	8.10	8.30
D3	9.10 TYP.		
e	1.20 BSC		
E	11.60	11.70	11.80
E1	10.30	10.40	10.50
E2	6.55	6.65	6.75
E3	9.60 TYP.		
F	3.80 TYP.		
F1	3.00 TYP.		
G	0.80	0.90	1.00
K	3.00	3.10	3.20
L	1.59	1.69	1.79
L1	0.54	0.64	0.74
L2	0.56	0.66	0.76
Ø	8°	10°	12°
Ø1	10°	12°	14°

< UNITS OF MEASURE = MILLIMETER >

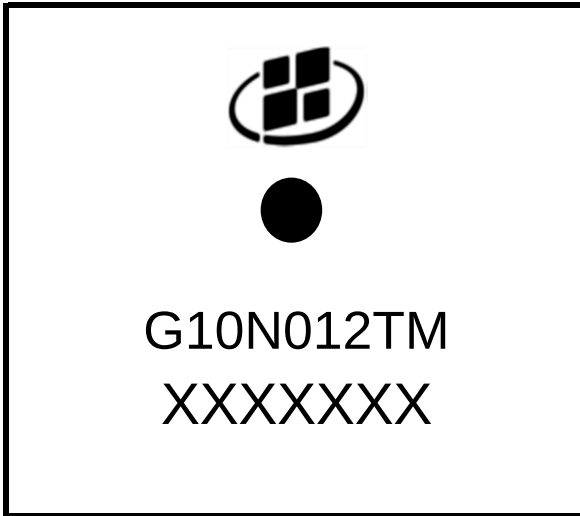
Package Outlines

POD2



SYMBOL	MIN		MAX
A	2.20		2.40
b	0.70		0.90
b1	9.70		9.90
b2	0.42		0.50
c	0.40		0.60
D	10.28		10.58
D2	3.10	3.30	3.50
E	9.70	9.90	10.10
E1	7.90	8.10	8.30
e	1.20 BSC		
H	11.48	11.68	11.88
H1	6.75	6.95	7.15
N	8		
J	3.00	3.15	3.30
K1	3.98	4.18	4.38
L	1.40	1.60	1.80
L1	0.60	0.70	0.80
L2	0.50	0.60	0.70
L4	1.00	1.15	1.30
θ	4°	7°	10°

Marking Information



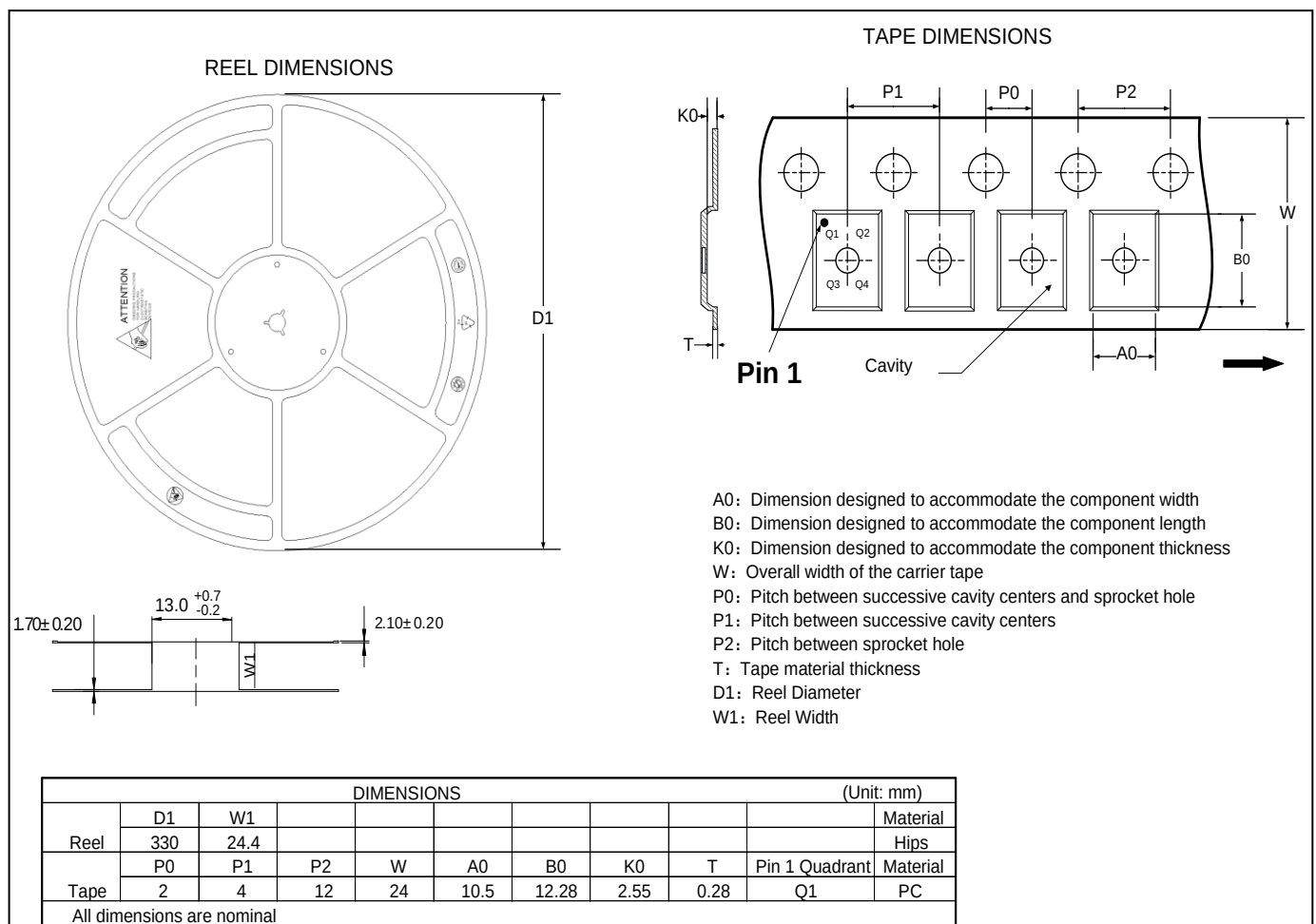
Note:

G10N012TM = Product Name Code

XXXXXXX = Date code

Contact ALKAIDSEMI sales for detail information

Reel Information



Revision History

Revision	Release Date	Remark
Rev.1.1	2023/3/1	

Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Alkaidsemi assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.